FAIRCHILD SEMICONDUCTOR

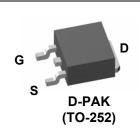
## 30V N-Channel PowerTrench<sup>®</sup> MOSFET

## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS( ON) and fast switching speed.

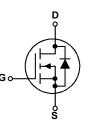
## **Applications**

- DC/DC converter
- Motor Drives



## Features

- 75 A, 30 V  $R_{DS(ON)}$  = 6 m $\Omega$  @ V<sub>GS</sub> = 10 V  $R_{DS(ON)} = 8 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Low gate charge
- · Fast switching
- High performance trench technology for extremely low R<sub>DS(ON)</sub>



## Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		30	V
$V_{\text{GSS}}$	Gate-Source Voltage		± 20	
ID	Drain Current – Continuous	(Note 3)	75	А
	– Pulsed	(Note 1a)	100	
P <sub>D</sub>	Power Dissipation for Single Operation	(Note 1)	71	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperat	ure Range	-55 to +175	°C

#### I nermal Characteristics Thermal Resistance Junction-to-Case (Note 1)

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	2.1	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	

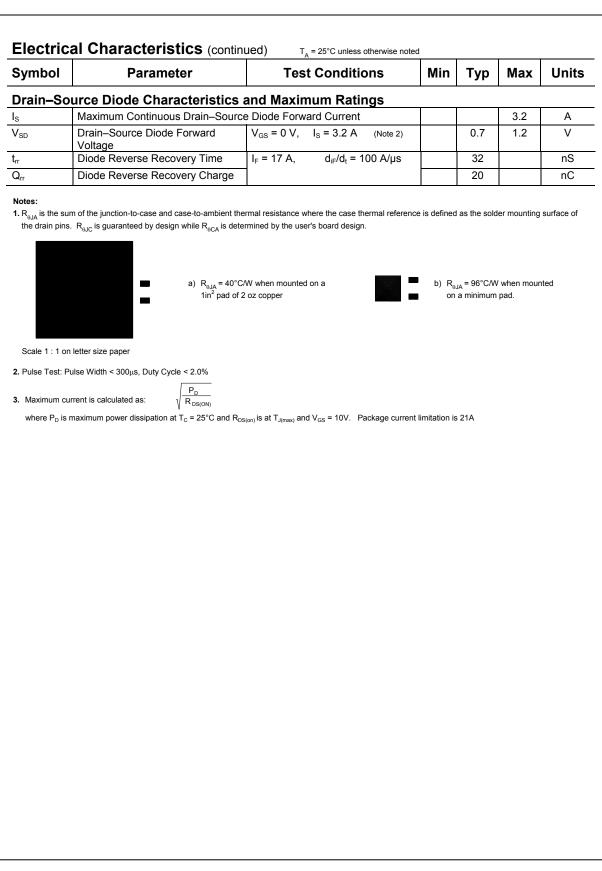
## Package Marking and Ordering Information

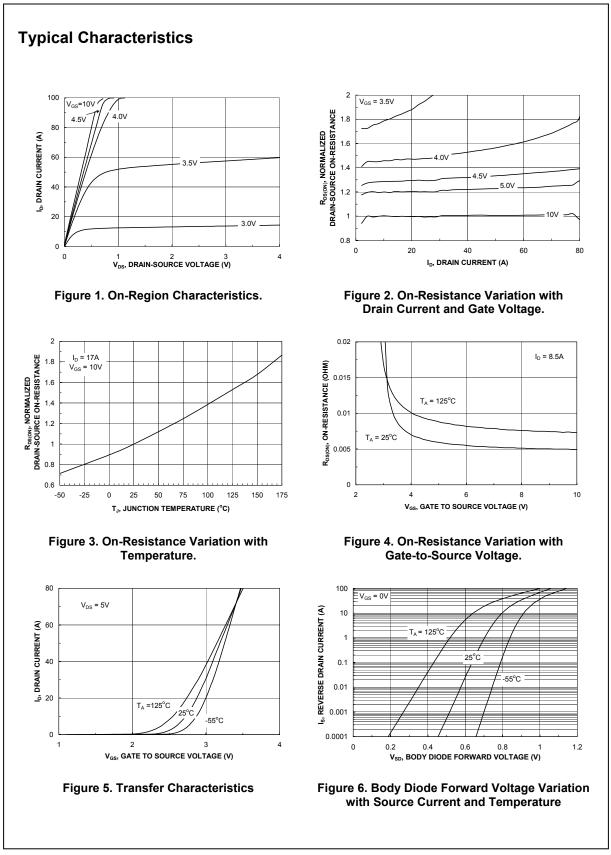
Device Marking	Device	Package	Reel Size	Tape width	Quantity
FDD6606	FDD6606	D-PAK (TO-252)	13"	12mm	2500 units

©2004 Fairchild Semiconductor Corporation

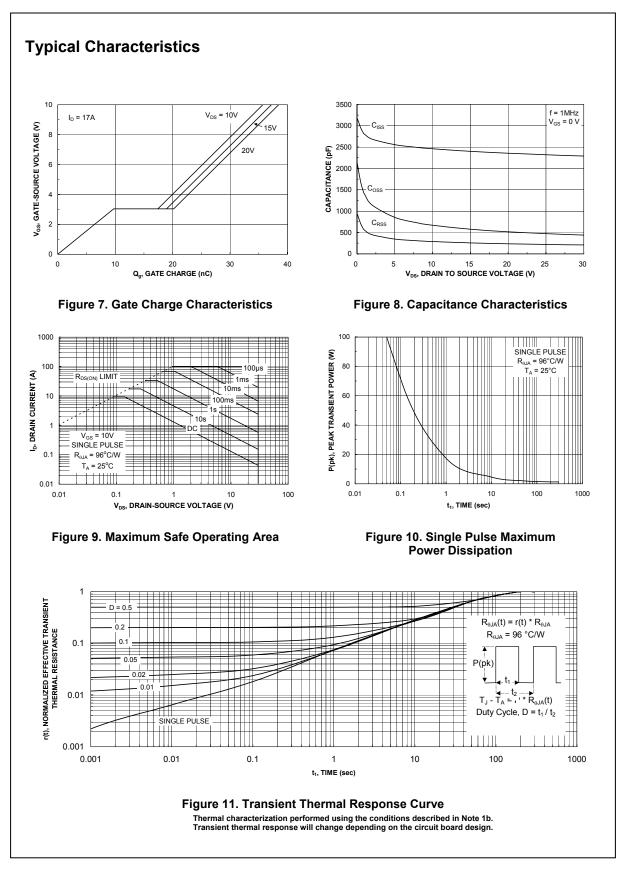
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
- Drain-So	urce Avalanche Ratings (Note	2)				
W <sub>DSS</sub>	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$ , $I_D = 17 \text{ A}$			240	mJ
I <sub>AR</sub>	Drain-Source Avalanche Current				17	A
Off Char	acteristics		1			
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	30			V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		20		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			10	μA
I <sub>GSS</sub>	Gate–Body Leakage	$V_{GS}$ = ± 20 V, $V_{DS}$ = 0 V			±100	nA
On Chara	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		-7		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance			5 6 8	6.0 8.0 11.9	mΩ
I <sub>D(on)</sub>	On-State Drain Current	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 5 V	50			А
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V$ , $I_{D} = 17 A$		65		S
Dynamic	Characteristics					
Ciss	Input Capacitance			2400		pF
Coss	Output Capacitance	$V_{DS} = 15 V$ , $V_{GS} = 0 V$ , f = 1.0 MHz		577		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			258		pF
R <sub>G</sub>	Gate Resistance	$V_{GS}$ = 15 mV, f = 1.0 MHz		1.4		Ω
Switchin	q Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn-On Delay Time			14	20	ns
tr	Turn–On Rise Time	$V_{DD} = 15 V$ , $I_D = 1 A$ ,		12	37	ns
$t_{d(off)}$	Turn–Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		38	64	ns
t <sub>f</sub>	Turn–Off Fall Time			18	32	ns
Qg	Total Gate Charge			24	31	nC
Q <sub>gs</sub>	Gate–Source Charge	$V_{DS} = 15V,$ $I_{D} = 17 A,$ $V_{GS} = 5 V$		10		nC
Q <sub>gd</sub>	Gate-Drain Charge			11		nC

FDD6606





FDD6606 Rev B (W)



FDD6606 Rev B (W)

### TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™	FACT Quiet Series™	ISOPLANAR™	POP™	Stealth™
ActiveArray™	FAST®	LittleFET™	Power247 <sup>™</sup>	SuperFET™
Bottomless™	FASTr™	MICROCOUPLER™	PowerSaver™	SuperSOT <sup>™</sup> -3
CoolFET™	FPS™	MicroFET™	PowerTrench <sup>®</sup>	SuperSOT <sup>™</sup> -6
CROSSVOLT™	FRFET™	MicroPak™	QFET <sup>®</sup>	SuperSOT <sup>™</sup> -8
DOME™	GlobalOptoisolator™	MICROWIRE™	QS™	SyncFET™
EcoSPARK™	GTO™່	MSX™	QT Optoelectronics <sup>™</sup>	TinyLogic <sup>®</sup>
E <sup>2</sup> CMOS <sup>™</sup>	HiSeC™	MSXPro™	Quiet Series <sup>™</sup>	TINYOPTO™
EnSigna™	I <sup>2</sup> C <sup>™</sup>	OCX™	RapidConfigure™	TruTranslation™
FACT™	ImpliedDisconnect™	OCXPro™	RapidConnect™	UHC™
Across the boar	d. Around the world.™	OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	UltraFET <sup>®</sup>
The Power Fran		OPTOPLANAR™	SMART START™	VCX™
Programmable A		PACMAN™	SPM™	

### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### **PRODUCT STATUS DEFINITIONS**

**Definition of Terms** 

Product Status	Definition
Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.
	Formative or In Design First Production Full Production